

# UNISONIC TECHNOLOGIES CO., LTD

UT3PP06 Preliminary Power MOSFET

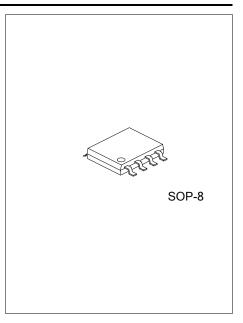
# -3A, -60V DUAL P-CHANNEL ENHANCEMENT MODE POWER MOSFET

# **■ DESCRIPTION**

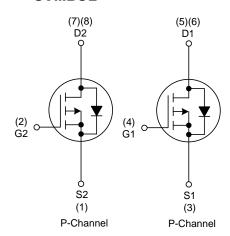
The UTC **UT3PP06** is a P-channel Power MOSFET, it uses UTC's advanced technology to provide the customers with low Rdson characteristic by high cell density trench technology.

#### **■ FEATURES**

- \*  $R_{DS(ON)} \le 160 \text{ m}\Omega$  @  $V_{GS}$ =-10V,  $I_{D}$ =-1.5A  $R_{DS(ON)} \le 200 \text{ m}\Omega$  @  $V_{GS}$ =-4.5V,  $I_{D}$ =-1.5A
- \* Fast Switching Speed
- \* Simple Drive Requirement



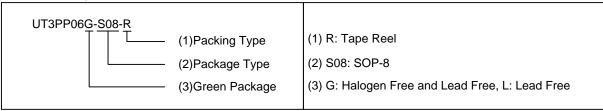
#### **■ SYMBOL**



#### **■ ORDERING INFORMATION**

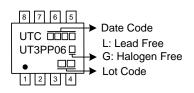
Ordering Number		Deelsene	Pin Assignment							Doolsing	
Lead Free	Halogen Free	Package	1	2	3	4	5	6	7	8	Packing
UT3PP06L- S08-R	UT3PP06G-S08-R	SOP-8	S2	G2	S1	G1	D1	D1	D2	D2	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



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# MARKING



# ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>A</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	-60	V
Gate-Source Voltage		$V_{GSS}$	±20	V
Drain Current	Continuous	Ι <sub>D</sub>	-3	Α
	Pulsed (Note 2)	$I_{DM}$	-6	Α
Avalanche Energy	valanche Energy Single Pulsed (Note 3)		28.6	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.6	V/nS
Power Dissipation		$P_D$	1	W
Junction Temperature		$T_J$	+150	°C
Storage Temperature		$T_{STG}$	-55 ~ <b>+</b> 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L =0.5mH,  $I_{AS}$  =-10.7A,  $V_{DD}$  = -25V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25°C.
- 4.  $I_{SD} \le -15.0A$ ,  $di/dt \le 200A/\mu s$ ,  $V_{DD} \le V_{(BR)DSS}$ ,  $T_J = 25^{\circ}C$ .

# ■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	$\theta_{JA}$	100	°C/W

Note: Device mounted on FR-4 substrate P<sub>C</sub> board, 2oz copper, with 1inch square copper plate.

# ■ **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub>=25°C, unless otherwise specified)

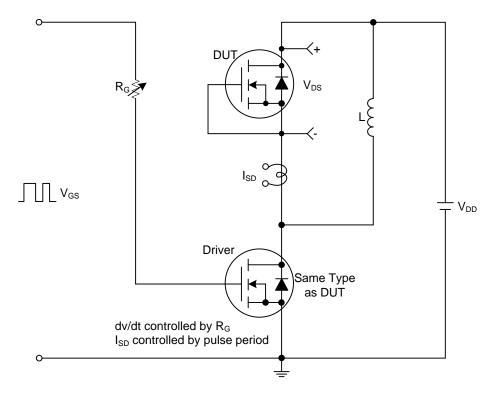
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PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		$BV_{DSS}$	$V_{GS}=0V$ , $I_D=-250\mu A$	-60			V		
Drain-Source Leakage Current		$I_{DSS}$	V <sub>DS</sub> =-60V, V <sub>GS</sub> =0V			-1	μΑ		
Cata Sauraa Laakaga Currant	rward	ı	$V_{DS}=0V$ , $V_{GS}=20V$			-60	nΑ		
Gate-Source Leakage Current Re	everse	I <sub>GSS</sub>	$V_{DS}$ =0V , $V_{GS}$ =-20V			±100	nΑ		
ON CHARACTERISTICS									
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$	-1.0		-3.0	V			
Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-1.5A			160	mΩ		
			V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1.5A			200	mΩ		
DYNAMIC PARAMETERS									
Input Capacitance		C <sub>ISS</sub>			550		pF		
Output Capacitance		Coss	V <sub>DS</sub> =-25V, V <sub>GS</sub> =0V, f=1.0MHz		43		pF		
Reverse Transfer Capacitance		$C_{RSS}$			32		pF		
SWITCHING PARAMETERS									
Total Gate Charge (Note 1)		$Q_{G}$	\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		13		nC		
Gate-Source Charge		$Q_GS$	$V_{DS}$ =-48V, $V_{GS}$ =-10V, $I_{D}$ =-3A,		2.2		nC		
Gate-Drain Charge		$Q_GD$	I <sub>G</sub> =-1mA (Note 1, 2)		1.8		nC		
Turn-ON Delay Time (Note 1)		t <sub>D(ON)</sub>			14		ns		
Turn-ON Rise Time		t <sub>R</sub>	$V_{DD}$ =-30V, $V_{GS}$ =-10V, $I_{D}$ =-3A,		18		ns		
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	R <sub>G</sub> =6Ω (Note 1, 2)		30		ns		
Turn-OFF Fall Time		t <sub>F</sub>			18		ns		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS									
Maximum Body-Diode Continuous Current		Is				-3	Α		
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				-6	Α		
Drain-Source Diode Forward Voltage (Note 1)		$V_{SD}$	I <sub>S</sub> =-3A, V <sub>GS</sub> =0V			1.4	V		
Body Diode Reverse Recovery Time (Note 1)		t <sub>rr</sub>	$I_S = -3A$ , $V_{GS} = 0V$ ,		35		ns		
Body Diode Reverse Recovery Cha	$Q_{rr}$	dI <sub>F</sub> /dt=100A/µs		36		nC			

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

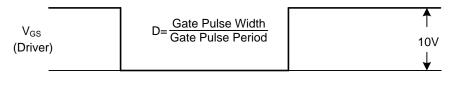
2. Essentially independent of operating temperature.

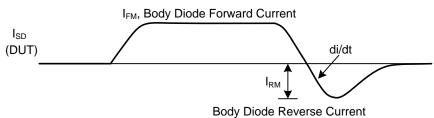


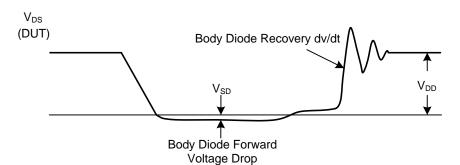
# ■ TEST CIRCUITS AND WAVEFORMS



# Peak Diode Recovery dv/dt Test Circuit



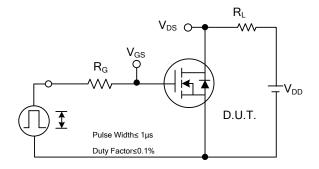


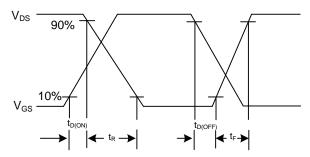


Peak Diode Recovery dv/dt Test Circuit and Waveforms

Peak Diode Recovery dv/dt Waveforms

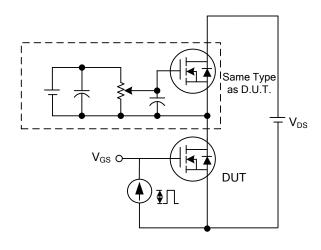
# ■ TEST CIRCUITS AND WAVEFORMS (Cont.)

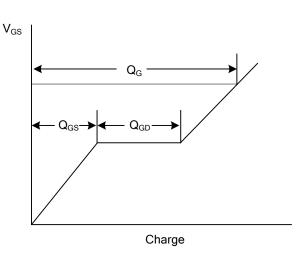




**Switching Test Circuit** 

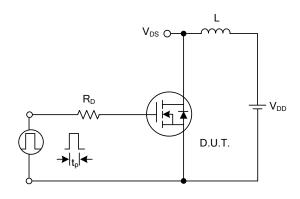
**Switching Waveforms** 

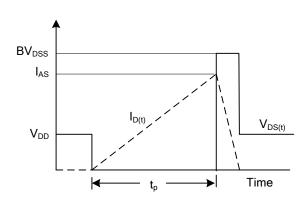




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 





**Unclamped Inductive Switching Test Circuit** 

**Unclamped Inductive Switching Waveforms** 

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